

Electronic Patent Application Fee Transmittal

Application Number:	10762789			
Filing Date:	22-Jan-2004			
Title of Invention:	Wafer, intermediate wafer assembly and associated method for fabricating a silicon on insulator wafer having an improved edge profile			
First Named Inventor/Applicant Name:	Douglas G. Anderson			
Filer:	Guy Randall Gosnell/Gwen Frickhoeffler			
Attorney Docket Number:	039035/267930			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Notice of appeal	1401	1	500	500
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 3 months with \$120 paid	1253	1	900	900
Miscellaneous:				
Total in USD (\$)				1400